

### IDT709279/69S/L

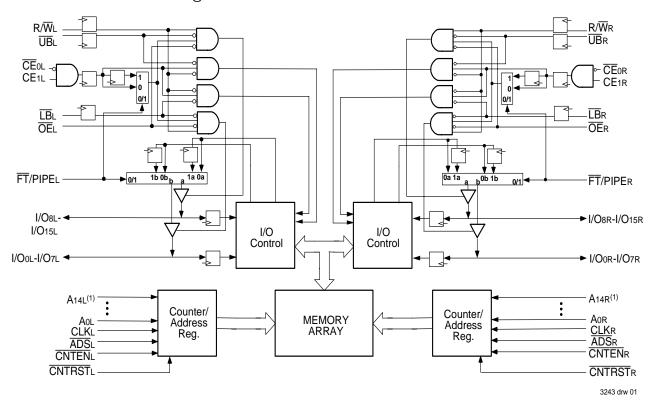
LEAD FINISH (SnPb) ARE IN EOL PROCESS - LAST TIME BUY EXPIRES JUNE 15, 2018

#### **Features**

- True Dual-Ported memory cells which allow simultaneous access of the same memory location
- High-speed clock to data access
  - Commercial: 9/12/15ns (max.)
  - Industrial: 12ns (max.)
- Low-power operation
  - IDT709279/69S
    - Active: 950mW (typ.)
    - Standby: 5mW (typ.)
  - IDT709279/69L
    - Active: 950mW (typ.)
    - Standby: 1mW (typ.)
- Flow-Through or Pipelined output mode on either port via the FT/PIPE pin
- Dual chip enables allow for depth expansion without additional logic

- Counter enable and reset features
- Full synchronous operation on both ports
  - 4ns setup to clock and 1ns hold on all control, data, and address inputs
  - Data input, address, and control registers
  - Fast 9ns clock to data out in the Pipelined output mode
  - Self-timed write allows fast cycle time
  - 15ns cycle time, 67MHz operation in Pipelined output mode
- Separate upper-byte and lower-byte controls for multiplexed bus and bus matching compatibility
- TTL- compatible, single 5V (±10%) power supply
- Industrial temperature range (-40°C to +85°C) is available for selected speeds
- Available in a 100-pin Thin Quad Flatpack (TQFP) package
- Green parts available. See ordering information

### Functional Block Diagram



### NOTE:

1. A<sub>14x</sub> is a NC for IDT709269.

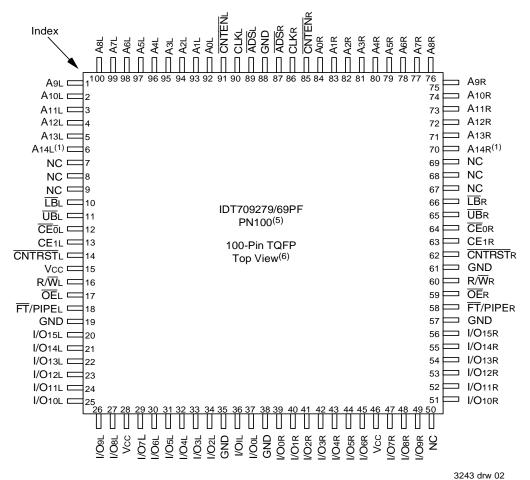
FEBRUARY 2018

### Description

The IDT709279/69 is a high-speed 32/16K x 16 bit synchronous Dual-Port RAM. The memory array utilizes Dual-Port memory cells to allow simultaneous access of any address from both ports. Registers on control, data, and address inputs provide minimal setup and hold times. The timing latitude provided by this approach allows systems to be designed with very short cycle times.

With an input data register, the IDT709279/69 has been optimized for applications having unidirectional or bidirectional data flow in bursts. An automatic power down feature, controlled by  $\overline{\text{CE}}$ 0 and CE1, permits the on-chip circuitry of each port to enter a very low standby power mode. Fabricated using CMOS high-performance technology, these devices typically operate on only 950mW of power.

## Pin Configurations (2,3,4)



#### 3243 UIW UZ

- 1. A<sub>14</sub>x is a NC for IDT709269.
- 2. All Vcc pins must be connected to power supply.
- 3. All GND pins must be connected to ground supply.
- 4. Package body is approximately 14mm x 14mm x 1.4mm
- 5. This package code is used to reference the package diagram.
- 6. This text does not indicate orientation of the actual part-marking.

### Pin Names

| Left Port                 | Right Port                 | Names                            |  |  |
|---------------------------|----------------------------|----------------------------------|--|--|
| CEOL, CE1L                | CEOR, CE1R                 | Chip Enables <sup>(3)</sup>      |  |  |
| $R/\overline{W}_L$        | R/W̄R                      | Read/Write Enable                |  |  |
| ŌĒL                       | <del>OE</del> r            | Output Enable                    |  |  |
| Aol - A14L <sup>(1)</sup> | Aor - A14R <sup>(1)</sup>  | Address                          |  |  |
| I/Ool - I/O15L            | I/Oor - I/O15R             | Data Input/Output                |  |  |
| CLKL                      | CLKR                       | Clock                            |  |  |
| <del>UB</del> ∟           | <del>UB</del> R            | Upper Byte Select <sup>(2)</sup> |  |  |
| <u>LB</u> ∟               | <del>LB</del> R            | Lower Byte Select <sup>(2)</sup> |  |  |
| ADSL                      | <del>ADS</del> R           | Address Strobe                   |  |  |
| CNTENL                    | <u>CNTEN</u> R             | Counter Enable                   |  |  |
| <u>CNTRST</u> ∟           | <u>CNTRST</u> <sub>R</sub> | Counter Reset                    |  |  |
| FT/PIPEL                  | FT/PIPER                   | Flow-Through/Pipeline            |  |  |
| V                         | SS                         | Power                            |  |  |
| G                         | ND                         | Ground                           |  |  |

### 3243 tbl 01

- 1. A14x is a NC for IDT709269.
- ATTALL S a No. 101 IDTALL STATE STA

# Truth Table I—Read/Write and Enable Control (1,2,3)

| ŌĒ | CLK | Œ | CE <sub>1</sub> | B | lВ | R/W | Upper Byte<br>I/O8-15 | Lower Byte<br>I/O <sub>0-7</sub> | Mode                     |
|----|-----|---|-----------------|---|----|-----|-----------------------|----------------------------------|--------------------------|
| Х  | 1   | Н | Χ               | Х | Х  | Х   | High-Z                | High-Z                           | Deselected—Power Down    |
| Х  | 1   | Χ | L               | Χ | Χ  | Χ   | High-Z                | High-Z                           | Deselected—Power Down    |
| Х  | 1   | L | Н               | Н | Н  | Х   | High-Z                | High-Z                           | Both Bytes Deselected    |
| Х  | 1   | L | Н               | L | Н  | L   | Din                   | High-Z                           | Write to Upper Byte Only |
| Х  | 1   | L | Н               | Н | L  | L   | High-Z                | Din                              | Write to Lower Byte Only |
| Х  | 1   | L | Н               | Ш | L  | L   | Din                   | Din                              | Write to Both Bytes      |
| L  | 1   | L | Η               | Ш | Н  | Η   | Dоит                  | High-Z                           | Read Upper Byte Only     |
| L  | 1   | L | Н               | Н | L  | Н   | High-Z                | Dout                             | Read Lower Byte Only     |
| L  | 1   | L | Н               | L | L  | Н   | Dоит                  | Dout                             | Read Both Bytes          |
| Н  | Х   | L | Н               | L | L  | Х   | High-Z                | High-Z                           | Outputs Disabled         |

#### NOTES:

- 1. "H" = VIH, "L" = VIL, "X" = Don't Care. 2. ADS, CNTEN, CNTRST = X.
- 3.  $\overline{\text{OE}}$  is an asynchronous input signal.

3243 tbl 02

Truth Table II—Address Counter Control<sup>(1,2)</sup>

| External<br>Address | Previous<br>Internal<br>Address | Internal<br>Address<br>Used | CLK | ĀDS              | CNTEN            | CNTRST           | I/O <sup>(3)</sup> | MODE  |  |
|---------------------|---------------------------------|-----------------------------|-----|------------------|------------------|------------------|--------------------|---|--|
| An                  | Х                               | An                          | 1   | L <sup>(4)</sup> | Х                | Н                | Dvo (n)            | External Address Used                                     |  |
| Х                   | An                              | An + 1                      | 1   | Н                | L <sup>(5)</sup> | Н                | Dvo(n+1)           | Counter Enabled—Internal Address generation               |  |
| Х                   | An + 1                          | An + 1                      | 1   | Н                | Н                | Н                | Dvo(n+1)           | External Address Blocked—Counter disabled (An + 1 reused) |  |
| Х                   | Х                               | A0                          | 1   | Х                | Х                | L <sup>(4)</sup> | Dvo(0)             | Counter Reset to Address 0                                |  |

NOTES: 3243 tbl 03

- 1. "H" = VIH, "L" = VIL, "X" = Don't Care.
- 2.  $\overline{CE}_0$ ,  $\overline{LB}$ ,  $\overline{UB}$ , and  $\overline{OE}$  = V<sub>IL</sub>; CE<sub>1</sub> and R/ $\overline{W}$  = V<sub>IH</sub>.
- 3. Outputs configured in Flow-Through Output mode: if outputs are in Pipelined mode the data out will be delayed by one cycle.
- 4. ADS is independent of all other signals including CEo, CE1, UB and LB.
- 5. The address counter advances if CNTEN = VIL on the rising edge of CLK, regardless of all other signals including CEo, CE1, UB and LB.

# Recommended Operating Temperature and Supply Voltage<sup>(1)</sup>

| Grade      | Ambient<br>Temperature | GND | Vcc               |
|------------|------------------------|-----|-------------------|
| Commercial | 0°C to +70°C           | 0V  | 5.0V <u>+</u> 10% |
| Industrial | -40°C to +85°C         | 0V  | 5.0V <u>+</u> 10% |

NOTES:

1. This is the parameter Ta. This is the "instant on" case temperature.

Recommended DC Operating Conditions

| Symbol | Parameter         | Min.                | Тур.               | Max. | Unit |
|--------|-------------------|---------------------|--------------------|------|------|
| Vcc    | Supply Voltage    | 4.5                 | 5.0                | 5.5  | ٧    |
| GND    | Ground            | 0                   | 0                  | 0    | V    |
| VIH    | 2.2               | _                   | 6.0 <sup>(1)</sup> | ٧    |      |
| VIL    | Input Low Voltage | -0.5 <sup>(2)</sup> | _                  | 0.8  | V    |

3243 tbl 05

3243 th I 07

### NOTES:

3243 tbl 04

- 1. VTERM must not exceed Vcc + 10%.
- 2.  $V_{IL} \ge -1.5V$  for pulse width less than 10ns.

## Absolute Maximum Ratings(1)

| Symbol               | Rating                                     | Commercial<br>& Industrial | Unit |
|----------------------|--|----------------------------|------|
| VTERM <sup>(2)</sup> | Terminal Voltage<br>with Respect<br>to GND | -0.5 to +7.0               | V    |
| TBIAS                | TemperatureUnder Bias                      | -55 to +125                | °C   |
| Tstg                 | Storage Temperature                        | -65 to +150                | °C   |
| NLT                  | Junction Temperature                       | +150                       | ۰C   |
| Іоит                 | DC Output Current                          | 50                         | mA   |

3243 tbl 06

#### NOTES

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may
  cause permanent damage to the device. This is a stress rating only and
  functional operation of the device at these or any other conditions above those
  indicated in the operational sections of this specification is not implied. Exposure
  to absolute maximum rating conditions for extended periods may affect
  reliability
- 2. VTERM must not exceed Vcc + 10% for more than 25% of the cycle time or 10ns maximum, and is limited to  $\leq$  20mA for the period of VTERM  $\geq$  Vcc + 10%.
- 3. Ambient Temperature Under Bias. No AC Conditions. Chip Deselect.

# Capacitance<sup>(1)</sup>

 $(TA = +25^{\circ}C, f = 1.0MHz)$ 

| Symbol              | Parameter          | Conditions <sup>(2)</sup> | Max. | Unit |
|---------------------|--------------------|---------------------------|------|------|
| CIN                 | Input Capacitance  | VIN = 0V                  | 9    | pF   |
| Соит <sup>(2)</sup> | Output Capacitance | Vout = 0V                 | 10   | pF   |

NOTES:

1. These parameters are determined by device characterization, but are not production tested.

2. Cout also references CI/o.

# DC Electrical Characteristics Over the Operating

Temperature Supply Voltage Range (Vcc = 5.0V ± 10%)

| •      |                                      |  | 709279 |      |      |
|--------|--------------------------------------|--|--------|------|------|
| Symbol | Parameter                            | Test Conditions                          | Min.   | Max. | Unit |
| LI     | Input Leakage Current <sup>(1)</sup> | Vcc = 5.5V, $Vin = 0V$ to $Vcc$          | -      | 10   | μΑ   |
| ILO    | Output Leakage Current               | CE0 = VIH or CE1 = VIL, VOUT = 0V to VCC |        | 10   | μΑ   |
| Vol    | Output Low Voltage                   | IoL = +4mA                               | -      | 0.4  | V    |
| Vон    | Output High Voltage                  | loн = -4mA                               | 2.4    | _    | V    |

3243 tbl 08

#### NOTE

1. At Vcc ≤ 2.0V input leakages are undefined.

# DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range $^{(6)}$ (Vcc = 5V $\pm$ 10%)

|        |  | cappiy voitage i  |        |        | 70927<br>Com'l      | 9/69X9<br>Only | 709279<br>Coi<br>& I | m'l        | 709279/<br>Com'l    |            |      |
|--------|--|---|--------|--------|---------------------|----------------|----------------------|------------|---------------------|------------|------|
| Symbol | Parameter  | Test Condition  | Versio | n      | Typ. <sup>(4)</sup> | Max.           | Typ. <sup>(4)</sup>  | Max.       | Typ. <sup>(4)</sup> | Max.       | Unit |
| Icc    | Dynamic Operating Current  | CEL and CER= VIL<br>Outputs Disabled f = fMAX <sup>(1)</sup>  | COM'L  | S<br>L | 210<br>210          | 390<br>350     | 200<br>200           | 345<br>305 | 190<br>190          | 325<br>285 | mA   |
|        | (Both Ports Active)  |   | IND    | S<br>L |                     |                | 200<br>200           | 380<br>340 |                     |            |      |
| ISB1   | Standby Current<br>(Both Ports - TTL   | $\overline{CE}L = \overline{CE}R = VIH$<br>$f = fMAX^{(1)}$   | COM'L  | S<br>L | 50<br>50            | 135<br>115     | 50<br>50             | 110<br>90  | 50<br>50            | 110<br>90  | mA   |
|        | Level Inputs)  |   | IND    | S<br>L |                     |                | 50<br>50             | 125<br>105 |                     |            |      |
| ISB2   | Standby Current<br>(One Port - TTL   | <u>CE</u> "A" = VIL and<br><u>CE</u> "B" = VIH <sup>(3)</sup>   | COM'L  | S<br>L | 140<br>140          | 270<br>240     | 130<br>130           | 230<br>200 | 120<br>120          | 220<br>190 | mA   |
|        | Level Inputs)  | Active Port Outputs<br>Disabled, f=fMAX <sup>(1)</sup>  | IND    | S<br>L |                     |                | 130<br>130           | 245<br>215 |                     |            |      |
| ISB3   | Full Standby Current<br>(Both Ports -  | Both Ports CER and CEL ≥ VCC - 0.2V   | COM'L  | S<br>L | 1.0<br>0.2          | 15<br>5        | 1.0<br>0.2           | 15<br>5    | 1.0<br>0.2          | 15<br>5    | mA   |
|        | CMOS Level Inputs) $ \begin{array}{c} \text{VIN} \geq \text{VCC} - 0.2 \text{V o} \\ \text{VIN} \leq 0.2 \text{V, f} = 0^{(2)} \end{array} $ | $VIN \ge VCC - 0.2V$ of $VIN \le 0.2V$ , $f = 0^{(2)}$  | IND    | S<br>L |                     |                | 1.0<br>0.2           | 15<br>5    |                     |            |      |
| ISB4   | (One Port -  | <u>CE</u> "A" ≤ 0.2V and<br><u>CE</u> "B" ≥ VCC - 0.2V <sup>(5)</sup>   | COM'L  | S<br>L | 130<br>130          | 245<br>225     | 120<br>120           | 205<br>185 | 110<br>110          | 195<br>175 | mA   |
|        | CMOS Level Inputs)   | $\begin{array}{l} \text{VIN} \geq \overline{\text{VCC}} - 0.2 \text{V or} \\ \text{VIN} \leq 0.2 \text{V, Active Port Outputs} \\ \text{Disabled, f} = \text{fMAX}^{(1)} \end{array}$ | IND    | S<br>L |                     |                | 120<br>120           | 220<br>200 | _                   |            |      |

NOTES:

3243 tbl 09

- 1. At f = fmax, address and control lines (except Output Enable) are cycling at the maximum frequency clock cycle of 1/tcvc, using "AC TEST CONDITIONS" at input levels of GND to 3V.
- 2. f = 0 means no address, clock, or control lines change. Applies only to input at CMOS level standby.
- 3. Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- 5.  $\overline{\text{CE}}\text{x} = \text{V}\text{IL} \text{ means } \overline{\text{CE}}\text{ox} = \text{V}\text{IL} \text{ and } \text{CE}\text{1x} = \text{V}\text{IH}$ 
  - $\overline{\text{CE}}\text{x} = \text{Vih means } \overline{\text{CE}}\text{ox} = \text{Vih or CE1x} = \text{Vil}$
  - $\overline{\text{CE}}\text{x} \leq 0.2 \text{V}$  means  $\overline{\text{CE}}\text{ox} \leq 0.2 \text{V}$  and  $\text{CE}\text{1x} \geq \text{Vcc}$  0.2 V
  - $\overline{\text{CE}}$ x  $\geq$  Vcc 0.2V means  $\overline{\text{CE}}$ 0x  $\geq$  Vcc 0.2V or CE1x  $\leq$  0.2V
  - "X" represents "L" for left port or "R" for right port.
- 6. 'X' in part numbers indicate power rating (S or L).

 $893\Omega$ 

5pF\*

3243 drw 05

### **AC Test Conditions**

| Input Pulse Levels            | GND to 3.0V       |
|-------------------------------|-------------------|
| Input Rise/Fall Times         | 3ns Max.          |
| Input Timing Reference Levels | 1.5V              |
| Output Reference Levels       | 1.5V              |
| Output Load                   | Figures 1,2 and 3 |

3243 tbl 10

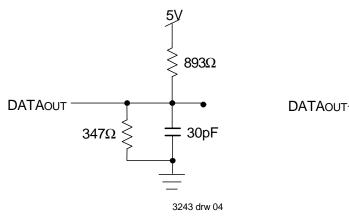


Figure 1. AC Output Test load.

Figure 2. Output Test Load (For tckLz, tckHz, toLz, and toHz).
\*Including scope and jig.

 $347\Omega \le$ 

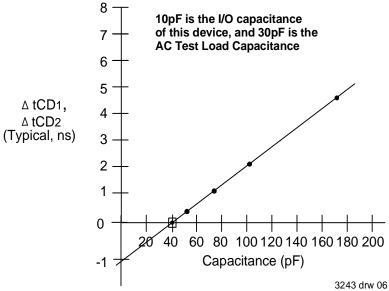


Figure 3. Typical Output Derating (Lumped Capacitive Load).

AC Electrical Characteristics Over the Operating Temperature Range (Read and Write Cycle Timing) $^{(3,4)}$  (Vcc = 5V ± 10%, TA = 0°C to +70°C)

| Symbol tcvc1 tcvc2 tcH1 | Parameter   | Min.    |      | α    | Ind  | X12 709279/69X15<br>Com'l Only |      |      |  |
|-------------------------|---|---------|------|------|------|--------------------------------|------|------|--|
| tcvc2                   |   | IVIII1. | Max. | Min. | Max. | Min.                           | Max. | Unit |  |
|                         | Clock Cycle Time (Flow-Through) <sup>(2)</sup>    | 25      |      | 30   | _    | 35                             | _    | ns   |  |
| tсн1                    | Clock Cycle Time (Pipelined) <sup>(2)</sup>       | 15      | -    | 20   | _    | 25                             | _    | ns   |  |
|                         | Clock High Time (Flow-Through) <sup>(2)</sup>     | 12      |      | 12   | _    | 12                             |      | ns   |  |
| tcl1                    | Clock Low Time (Flow-Through) <sup>(2)</sup>      | 12      | -    | 12   | _    | 12                             | _    | ns   |  |
| tch2                    | Clock High Time (Pipelined) <sup>(2)</sup>        | 6       | -    | 8    | _    | 10                             | _    | ns   |  |
| tcl2                    | Clock Low Time (Pipelined) <sup>(2)</sup>         | 6       |      | 8    | _    | 10                             |      | ns   |  |
| tr                      | Clock Rise Time                                   | _       | 3    |      | 3    | _                              | 3    | ns   |  |
| tr                      | Clock Fall Time                                   |         | 3    |      | 3    | _                              | 3    | ns   |  |
| tsa                     | Address Setup Time                                | 4       |      | 4    | _    | 4                              | _    | ns   |  |
| tha                     | Address Hold Time                                 | 1       |      | 1    | _    | 1                              | _    | ns   |  |
| tsc                     | Chip Enable Setup Time                            | 4       | -    | 4    | _    | 4                              | _    | ns   |  |
| tнc                     | Chip Enable Hold Time                             | 1       |      | 1    | _    | 1                              | _    | ns   |  |
| tsb                     | Byte Enable Setup Time                            | 4       |      | 4    | _    | 4                              | _    | ns   |  |
| tнв                     | Byte Enable Hold Time                             | 1       | _    | 1    | _    | 1                              | _    | ns   |  |
| tsw                     | R/W Setup Time                                    | 4       |      | 4    | _    | 4                              | _    | ns   |  |
| thw                     | $R/\overline{W}$ Hold Time                        | 1       |      | 1    | _    | 1                              | _    | ns   |  |
| tsd                     | Input Data Setup Time                             | 4       | _    | 4    | _    | 4                              | _    | ns   |  |
| thd                     | Input Data Hold Time                              | 1       |      | 1    | _    | 1                              | _    | ns   |  |
| tsad                    | ADS Setup Time                                    | 4       | _    | 4    | _    | 4                              | _    | ns   |  |
| thad                    | ADS Hold Time                                     | 1       | _    | 1    | _    | 1                              | _    | ns   |  |
| tscn                    | CNTEN Setup Time                                  | 4       |      | 4    | _    | 4                              | _    | ns   |  |
| then                    | CNTEN Hold Time                                   | 1       | _    | 1    | _    | 1                              | _    | ns   |  |
| tsrst                   | CNTRST Setup Time                                 | 4       | _    | 4    | _    | 4                              | _    | ns   |  |
| thrst                   | CNTRST Hold Time                                  | 1       | _    | 1    | _    | 1                              | _    | ns   |  |
| toe                     | Output Enable to Data Valid                       | _       | 9    |      | 12   | _                              | 15   | ns   |  |
| tolz                    | Output Enable to Output Low-Z <sup>(1)</sup>      | 2       | _    | 2    | _    | 2                              | _    | ns   |  |
| tонz                    | Output Enable to Output High-Z <sup>(1)</sup>     | 1       | 7    | 1    | 7    | 1                              | 7    | ns   |  |
| tcd1                    | Clock to Data Valid (Flow-Through) <sup>(2)</sup> | _       | 20   |      | 25   | _                              | 30   | ns   |  |
| tcD2                    | Clock to Data Valid (Pipelined) <sup>(2)</sup>    | _       | 9    | _    | 12   | _                              | 15   | ns   |  |
| toc                     | Data Output Hold After Clock High                 | 2       | _    | 2    | _    | 2                              | _    | ns   |  |
| tскнz                   | Clock High to Output High-Z <sup>(1)</sup>        | 2       | 9    | 2    | 9    | 2                              | 9    | ns   |  |
| tcklz                   | Clock High to Output Low-Z <sup>(1)</sup>         | 2       | _    | 2    | _    | 2                              | _    | ns   |  |
| Port-to-Port D          | Delay   | •       | -    | -    | -    | -                              | -    |      |  |
| tcwdd                   | Write Port Clock High to Read Data Delay          | _       | 35   | _    | 40   | _                              | 50   | ns   |  |
| tccs                    | Clock-to-Clock Setup Time                         | _       | 15   |      | 15   | _                              | 20   | ns   |  |

NOTES:

32//3 tbl 11

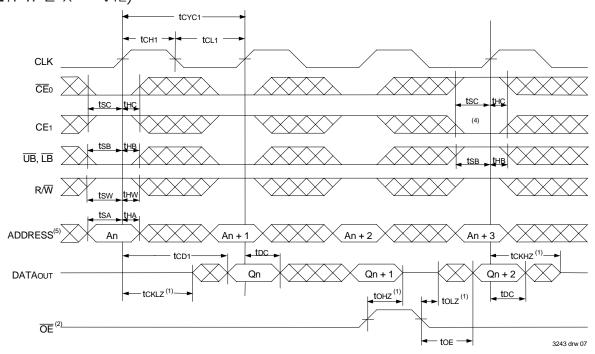
<sup>1.</sup> Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2). This parameter is guaranteed by device characterization, but is not production tested.

<sup>2.</sup> The Pipelined output parameters (tcvc2, tcb2) apply to either or both left and right ports when FT/PIPE = VIH. Flow-through parameters (tcvc1, tcb1) apply when FT/PIPE = VIL for that port.

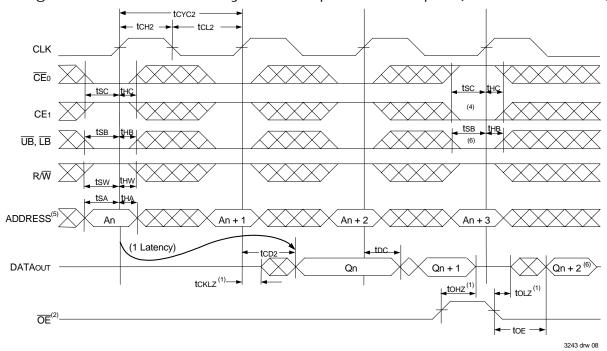
<sup>3.</sup> All input signals are synchronous with respect to the clock except for the asynchronous Output Enable (OE) and FT/PIPE. FT/PIPE should be treated as a DC signal, i.e. steady state during operation.

<sup>4. &#</sup>x27;X' in part number indicates power rating (S or L).

# Timing Waveform of Read Cycle for Flow-Through Output $(\mathbf{FT}/PIPE"x" = VIL)^{(3,7)}$

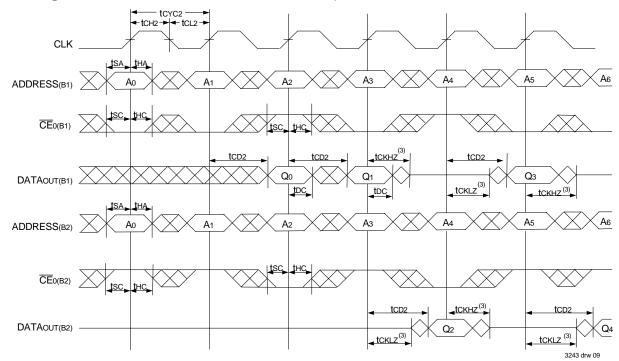


# Timing Waveform of Read Cycle for Pipelined Output ( $\overline{FT}$ /PIPE"X" = VIH) $^{(3,7)}$

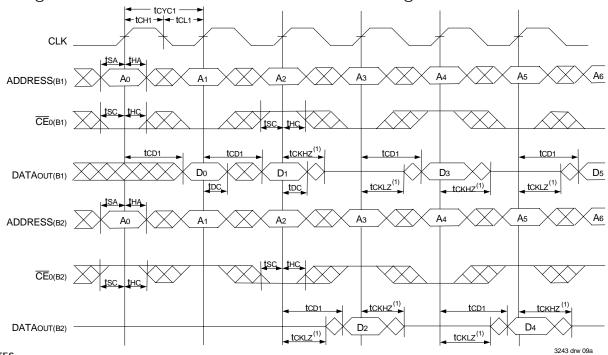


- 1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
- 2.  $\overline{\text{OE}}$  is asynchronously controlled; all other inputs are synchronous to the rising clock edge.
- 3.  $\overline{ADS} = VIL$ ,  $\overline{CNTEN}$  and  $\overline{CNTRST} = VIH$ .
- 4. The output is disabled (High-Impedance state) by  $\overline{\text{CE}}_0 = \text{V}_{\text{IH}}$ ,  $\overline{\text{CE}}_1 = \text{V}_{\text{II}}$ ,  $\overline{\text{UB}} = \text{V}_{\text{IH}}$ , or  $\overline{\text{LB}} = \text{V}_{\text{IH}}$  following the next rising edge of the clock. Refer to Truth Table 1.
- Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers
  are for reference use only.
- 6. If  $\overline{\sf UB}$  or  $\overline{\sf LB}$  was HIGH, then the Upper Byte and/or Lower Byte of DATAout for Qn + 2 would be disabled (High-Impedance state).
- 7. "x" denotes Left or Right port. The diagram is with respect to that port.

# Timing Waveform of a Bank Select Pipelined Read (1,2)



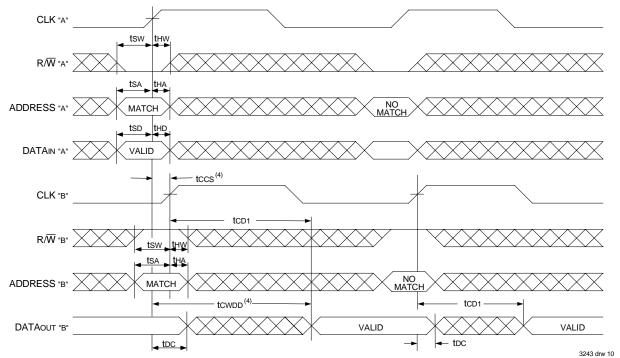
# Timing Waveform of a Bank Select Flow-Through Read<sup>(6)</sup>



- 1. B1 Represents Bank #1; B2 Represents Bank #2. Each Bank consists of one IDT709279/69 for this waveform, and are setup for depth expansion in this example. ADDRESS(B1) = ADDRESS(B2) in this situation.
- 2.  $\overline{\text{UB}}$ ,  $\overline{\text{LB}}$ ,  $\overline{\text{OE}}$ , and  $\overline{\text{ADS}}$  = VIL; CE1(B1), CE1(B2), R/W,  $\overline{\text{CNTEN}}$ , and  $\overline{\text{CNTRST}}$  = VIH.
- 3. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
- 4.  $\overline{\text{CE}}_0$ ,  $\overline{\text{UB}}$ ,  $\overline{\text{LB}}$ , and  $\overline{\text{ADS}}$  = VIL; CE1,  $\overline{\text{CNTEN}}$ , and  $\overline{\text{CNTRST}}$  = VIH.
- 5.  $\overline{OE}$  = V<sub>IL</sub> for the Right Port, which is being read from.  $\overline{OE}$  = V<sub>IH</sub> for the Left Port, which is being written to.
- 6. If tccs ≤ maximum specified, then data from right port READ is not valid until the maximum specified for tcwpp.

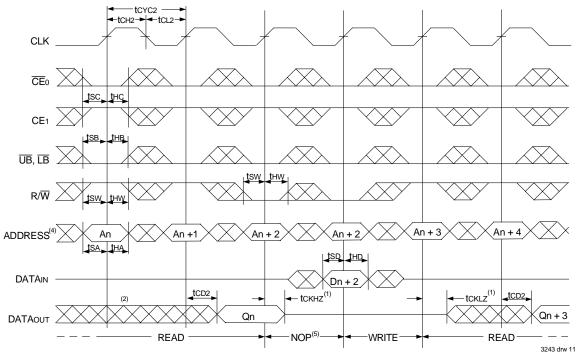
  If tccs > maximum specified, then data from right port READ is not valid until tccs + tcp1. tcwpp does not apply in this case.

# Timing Waveform with Port-to-Port Flow-Through Read (1,2,3,5)

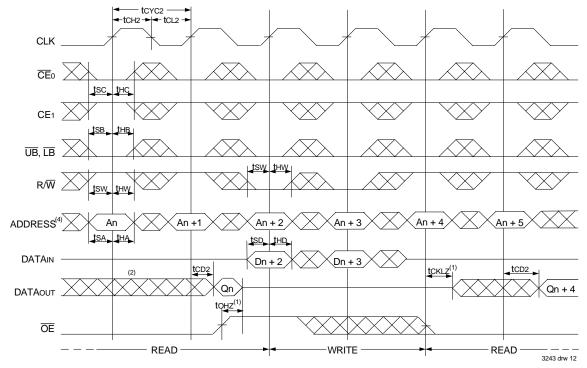


- 1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
- 2.  $\overline{CE}_0$ ,  $\overline{UB}$ ,  $\overline{LB}$ , and  $\overline{ADS} = V_{IL}$ ;  $CE_1$ ,  $\overline{CNTEN}$ , and  $\overline{CNTRST} = V_{IH}$ .
- 3.  $\overline{OE}$  = VIL for the Right Port, which is being read from.  $\overline{OE}$  = VIH for the Left Port, which is being written to.
- 4. If tccs ≤ maximum specified, then data from right port READ is not valid until the maximum specified for tcwpb.
  If tccs > maximum specified, then data from right port READ is not valid until tccs + tcp1. tcwpb does not apply in this case.
- 5. All timing is the same for both left and right ports. Port "A" may be either left or right port. Port "B" is the opposite of Port "A".

# Timing Waveform of Pipelined Read-to-Write-to-Read (**OE** = VIL)(3)

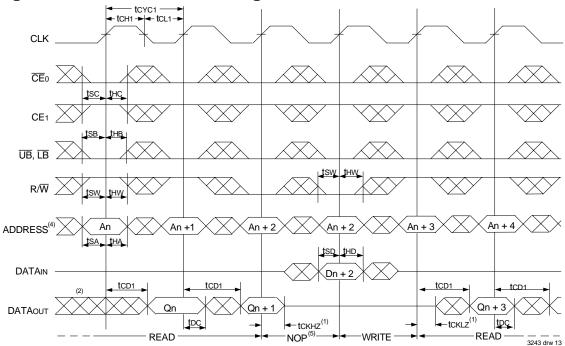


# Timing Waveforn of Pipelined Read-to-Write-to-Read (OE Controlled)(3)

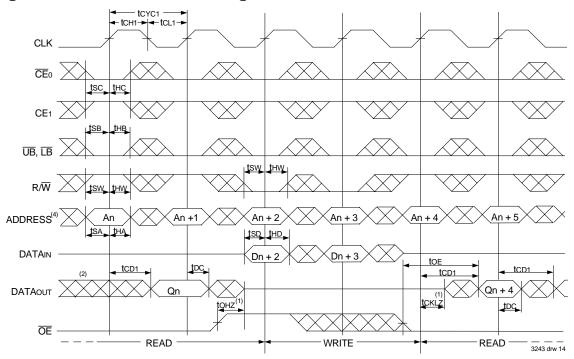


- 1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
- 2. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
- 3. CEo, UB, LB, and ADS = VIL; CE1, CNTEN, and CNTRST = VIH.
- Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- 5. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

# Timing Waveform of Flow-Through Read-to-Write-to-Read (**OE** = VIL)(3)

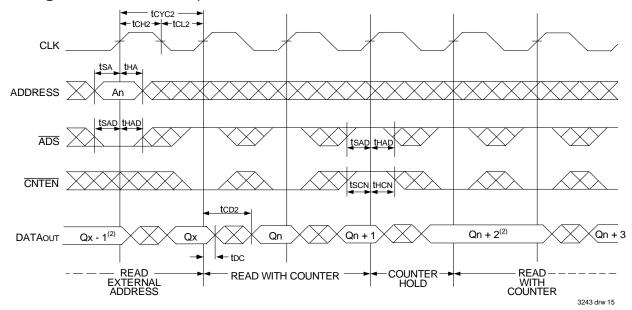


# Timing Waveform of Flow-Through Read-to-Write-to-Read (**OE** Controlled)<sup>(3)</sup>

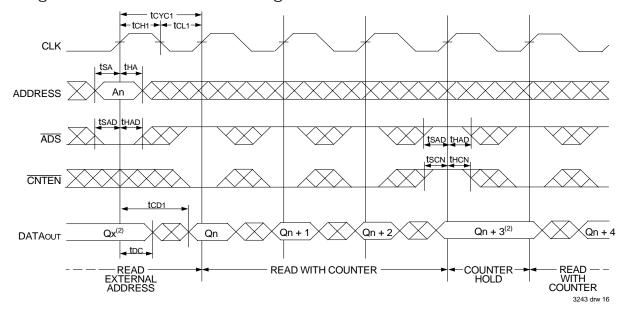


- $1. \ \ Transition \ is \ measured \ OmV \ from \ Low \ or \ High-impedance \ voltage \ with \ the \ Output \ Test \ Load \ (Figure \ 2).$
- 2. Output state (High, Low, or High-impedance is determined by the previous cycle control signals.
- 3. CEo, UB, LB, and ADS = VIL; CE1, CNTEN, and CNTRST = VIH.
- Addresses do not have to be accessed sequentially since ADS = VIL constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- 5. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be re-written to guarantee data integrity.

# Timing Waveform of Pipelined Read with Address Counter Advance<sup>(1)</sup>

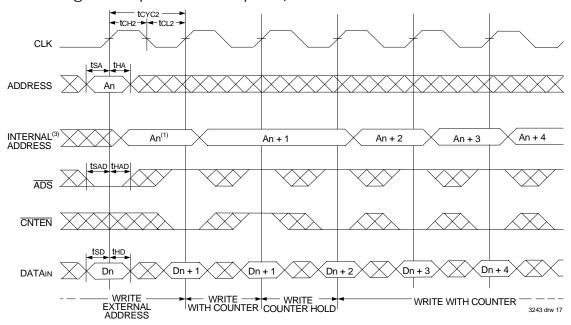


# $Timing\,Wave form\,of\,Flow-Through\,Read\,with\,Address\,Counter\,Advance^{(1)}$

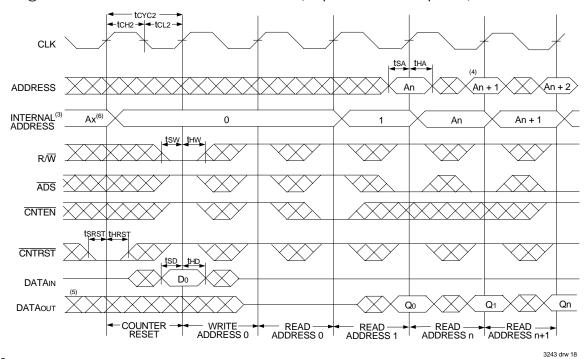


- 1.  $\overline{\text{CE}}_0$ ,  $\overline{\text{OE}}$ ,  $\overline{\text{UB}}$ , and  $\overline{\text{LB}}$  = VIL; CE1, R/ $\overline{\text{W}}$ , and  $\overline{\text{CNTRST}}$  = VIH.
- 2. If there is no address change via  $\overline{ADS} = V_{IL}$  (loading a new address) or  $\overline{CNTEN} = V_{IL}$  (advancing the address), i.e.  $\overline{ADS} = V_{IH}$  and  $\overline{CNTEN} = V_{IH}$ , then the data output remains constant for subsequent clocks.

# Timing Waveform of Write with Address Counter Advance (Flow-Through or Pipelined Outputs)(1)



# Timing Waveform of Counter Reset (Pipelined Outputs)(2)



- 1.  $\overline{CE}_0$ ,  $\overline{UB}$ ,  $\overline{LB}$ , and  $R/\overline{W} = VIL$ ;  $CE_1$  and  $\overline{CNTRST} = VIH$ .
- 2.  $\overline{CE}_0$ ,  $\overline{UB}$ ,  $\overline{LB}$  = VIL; CE1 = VIH.
- 3. The "Internal Address" is equal to the "External Address" when  $\overline{ADS} = V_{IL}$  and equals the counter output when  $\overline{ADS} = V_{IH}$ .
- 4. Addresses do not have to be accessed sequentially since ADS = V<sub>IL</sub> constantly loads the address on the rising edge of the CLK; numbers are for reference use
- 5. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
- 6. No dead cycle exists during counter reset. A READ or WRITE cycle may be coincidental with the counter reset cycle. ADDRo will be accessed. Extra cycles are shown here simply for clarification.
- CNTEN = VIL advances Internal Address from 'An' to 'An +1'. The transition shown indicates the time required for the counter to advance. The 'An +1'Address is written to during this cycle.

### A Functional Description

The IDT709279/69 provides a true synchronous Dual-Port Static RAM interface. Registered inputs provide minimal set-up and hold times on address, data, and all critical control inputs. All internal registers are clocked on the rising edge of the clock signal, however, the self-timed internal write pulse is independent of the LOW to HIGH transition of the clock signal.

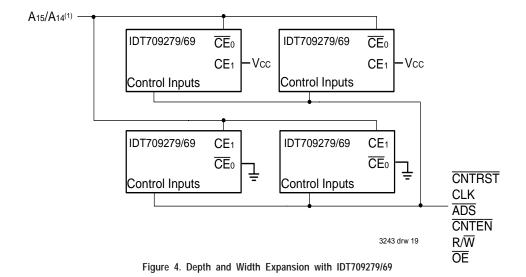
An asynchronous output enable is provided to ease asynchronous bus interfacing. Counter enable inputs are also provided to stall the operation of the address counters for fast interleaved memory applications.

A HIGH on  $\overline{\text{CE}}_0$  or a LOW on CE<sub>1</sub> for one clock cycle will power down the internal circuitry to reduce static power consumption. Multiple chip enables allow easier banking of multiple IDT709279/69's for depth expansion configurations. When the Pipelined output mode is enabled, two cycles are required with  $\overline{\text{CE}}_0$  LOW and CE<sub>1</sub> HIGH to re-activate the outputs.

### Depth and Width Expansion

The IDT709279/69 features dual chip enables (refer to Truth Table I) in order to facilitate rapid and simple depth expansion with no requirements for external logic. Figure 4 illustrates how to control the various chip enables in order to expand two devices in depth.

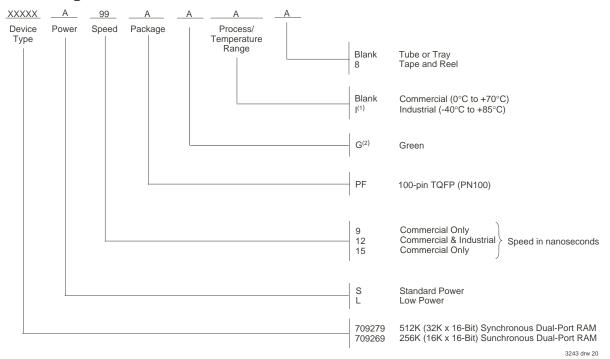
The IDT709279/69 can also be used in applications requiring expanded width, as indicated in Figure 4. Since the banks are allocated at the discretion of the user, the external controller can be set up to drive the input signals for the various devices as required to allow for 32-bit or wider applications.



NOTE:

1. A14 is for IDT709269.

### Ordering Information



#### NOTES:

- $1.\ Industrial\ temperature\ range\ is\ available.\ For\ specific\ speeds, packages\ and\ powers\ contact\ your\ sales\ of fice.$
- 2. Green parts available. For specific speeds, packages and powers contact your local sales office. LEAD FINISH (SnPb) parts are in EOL process. Product Discontinuation Notice - PDN# SP-17-02

Ordering Information for Flow-through Devices

| <u>Ordering miormation to</u> | 1 1 10W-till ough Devices |
|-------------------------------|---------------------------|
| Old Flow-through Part         | New Combined Part         |
| 70927S/L20                    | 709279S/L9                |
| 70927S/L25                    | 709279S/L12               |
| 70927S/L30                    | 709279S/L15               |

3243 tbl 12

### IDT Clock Solution for IDT709279/69 Dual-Port

|   | 1BT Glock Goldtight of the 1767217167 Built of the |                              |     |                      |                                    |                      |                     |                         |  |
|---|--|------------------------------|-----|----------------------|------------------------------------|----------------------|---------------------|-------------------------|--|
| 1 | IDT Dual-Port<br>Part Number                       | Dual-Port I/O Specitications |     | Clock Specifications |                                    |                      |                     | IDT                     |  |
|   |  | Voltage                      | I/O | Input<br>Capacitance | Input Duty<br>Cycle<br>Requirement | Maximum<br>Frequency | Jitter<br>Tolerance | Non-PLL<br>Clock Device |  |
|   | 709279/69  | 5                            | TTL | 9pF                  | 40%                                | 100                  | 150ps               | 49FCT805T               |  |

3243 tbl 13

## Datasheet Document History

12/9/98: Initiated datasheet document history

Converted to new format

Cosmetic and typographical corrections Added additional notes to pin configurations Pages 13 & 14 Updated timing waveforms

Page 15 Added Depth and Width Expansion section

06/03/99: Changed drawing format

Page 3 Deleted note 6 for Table II

11/10/99: Replaced IDT logo

03/31/00: Combined Pipelined 709279 family and Flow-through 70927 family offerings into one data sheet

Changed ±200mV in waveform notes to 0mV

Added corresponding part chart with ordering information

05/24/00: Page 1 Inserted diamond in copy

Page 4 Changed information in Truth Table II, Increased storage temperature parameter, clarified Taparameter

Page 5 Changed DC Electrical parameters-changed wording from "Open" to "Disabled"

Page 16 Fixed typeface in heading

Added Industrial Temperature Ranges and removed related notes

08/24/01: Pages 1, 16 and Page Header Removed Preliminary status

Page 5 & 7 Removed Industrial Temperature Ranges for 15ns speed from DC and AC Electrical Characteristics

Page 16 Removed Industrial Temperature from 15ns speed in ordering information

06/21/04: Consolidated multiple devices into one datasheet

Page 2 Added date revision to pin configuration

Added Junction Temperature to Absolute Maximum Ratings Table

Added Ambient Temperature footnote

Page 5 & 6 Added 6ns & 7ns speed DC power numbers to the DC Electrical Characteristics Table Page 8 Added 6ns & 7ns speed AC timing numbers to the AC Electrical Characteristics Table

Page 17 Added 6ns & 7ns speed grades to ordering information

Added IDT Clock Solution Table

Page 1 & 18 Replaced old ® logo with new ™ logo

01/29/09: Page 17 Removed "IDT" from orderable part number

06/24/15: Page 1 Added green availability to Features

Page 2 Removed IDT in reference to fabrication

Page 2 Removed date from the 100-pin TQFP configuration

Page 2 & 17 The package code PN100-1 changed to PN100 to match standard package codes Page 5 Removed the X6 & X7 speed grade options and combined the X9, X12 & X15 speed grade

options into one DC Elec Chars table

Removed the X6 & X7 speed grade options from the AC Elec Chars table Page 7

Page 16 Added Green and Tape & Reel indicators to the Ordering Information

02/02/18: Product Discontinuation Notice - PDN# SP-17-02

Last time buy expires June 15, 2018

